

iC-SM2L LGA SM2C

2MM MR-SENSOR PACKAGE SPECIFICATION

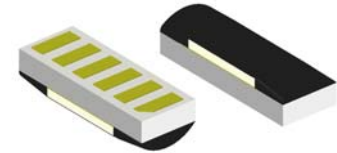
preliminary



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ORDERING INFORMATION

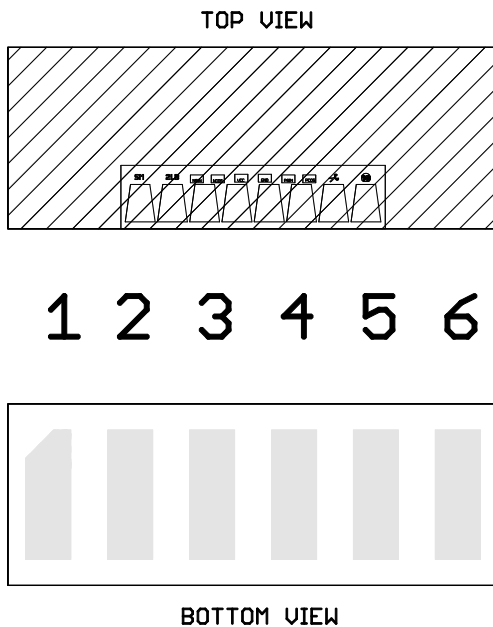
Type	Package	Options	Order Designation
iC-SM2L	LGA SM2C	none	iC-SM2L LGA SM2C



7.6 mm x 2.8 mm

PIN CONFIGURATION

PIN FUNCTIONS



No.	Name	Function
1	NCOS	Inverted Cosine Output
2	PCOS	Noninverted Cosine Output
3	VCC	Supply Voltage
4	GND	Ground
5	NSIN	Inverted Sine Output
6	PSIN	Noninverted Sine Output

DR8_SM2C_SM2L_PIN

ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Parameter	Conditions	Fig.				Unit
					Min.	Typ.	Max.	
TG1	Ta	Operating Ambient Temperature Range (extended temperature range on request)			-20		90	°C
TG2	Ts	Storage Temperature Range			-30		110	°C
TG3	Tl	Lead Temperature	$t_{pk} < 20$ s, convection reflow $t_{pk} < 20$ s, vapour phase TOL (time on label) 8 h; please refer to customer information file No. 7 for details				260 230	°C °C

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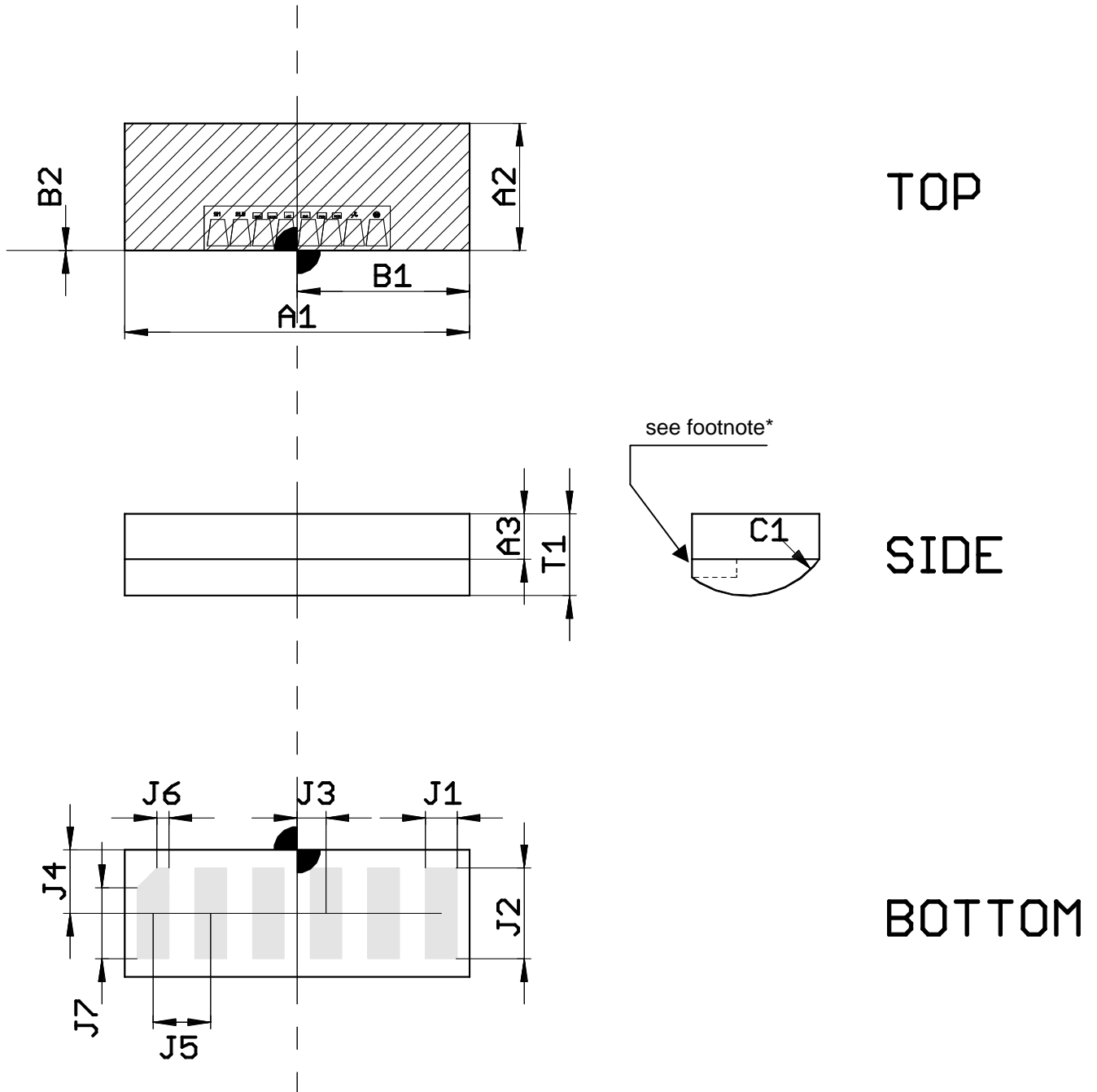
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PHYSICAL DIMENSIONS



DRB_SM2C_SM2L_MEAS

* die edge exposed; avoid mechanical and electrical contact.

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REVISION HISTORY

Rev	Notes	Pages affected
1	Initial version	
2	Drawings, Dimension Table	1,2,3
3	Solder conditions, Footnote on page 2, Disclaimer	1,2,3

GENERAL HANDLING INSTRUCTIONS

After opening the dry pack, devices must be mounted within 8 hours (in factory conditions of maximum 30°C / 60% RH) or must be stored at <10% RH. Devices require baking before mounting if the Humidity Indicator Card shows >10% when read at 23°C ±5°C or if the conditions mentioned above are not met. Devices may be baked for 72 hours at 100°C using high-temperature device containers (trays).

Samples:

Samples may not be subject for dry pack delivery, and, in that case, are not intended for reflow soldering.

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We understand suitable application of our published designs to be state-of-the-art technology which can no longer be classed as inventive under the stipulations of patent law. Our explicit application notes are to be treated only as mere examples of the many possible and extremely advantageous uses our products can be put to.